

# STPS2L60-Y

# Automotive power Schottky rectifier

### **Features**

- AEC-Q101 qualified
- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature package
- Avalanche capability specified
- ECOPACK<sup>®</sup>2 compliant component

### **Description**

This power Schottky rectifier is suited to switched mode power supplies and high frequency DC to DC converters for automative applications.

Packaged in SMA, this device is especially intended for use in low voltage, high frequency inverters and small battery chargers.

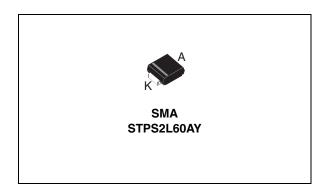


Table 1. Device summary

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Symbol	Value			
I <sub>F(AV)</sub>	2 A			
V <sub>RRM</sub>	60 V			
T <sub>j</sub> (max)	150 °C			
V <sub>F</sub> (max)	0.55 V			

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STPS2L60-Y **Characteristics** 

#### 1 **Characteristics**

Table 2. **Absolute ratings (limiting values)** 

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage		60	V
I <sub>F(RMS)</sub>	Forward rms voltage		10	Α
I <sub>F(AV)</sub>	Average forward current	2	Α	
I <sub>FSM</sub>	Surge non repetitive forward current	75	Α	
P <sub>ARM</sub>	Repetitive peak avalanche power	1600	W	
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C	
T <sub>j</sub>	Operating junction temperature range <sup>(1)</sup>	-40 to +150	°C	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	

 $<sup>\</sup>frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Test conditions	Value	Unit
R <sub>th(j-l)</sub>	Junction-lead	25	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage	T <sub>j</sub> = 25 °C	V - V			100	μΑ
'R`	current	T <sub>j</sub> = 100 °C	$V_R = V_{RRM}$		2	10	mA
		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 2 A			0.60	
V <sub>E</sub> <sup>(1)</sup>	V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 125 °C	IF - Z A		0.51	0.55	v
ver i orward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 4 A			0.77	V	
	T <sub>j</sub> = 125 °C	1F - + A		0.62	0.67		

<sup>1.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

To evaluate the conduction losses use the following equation: P = 0.43 x  $I_{F(AV)}$  + 0.06  $I_{F}^{2}_{(RMS)}$ 

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$$P = 0.43 \times I_{E(AV)} + 0.06 I_{E^{2}(BMS)}$$

STPS2L60-Y Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature ( $\delta$  = 0.5)

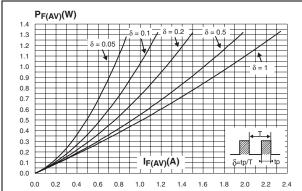
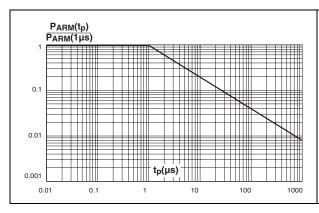


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature



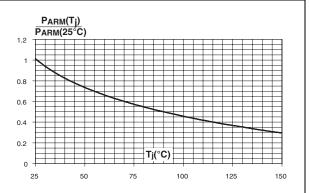
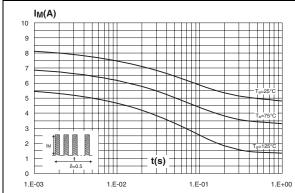
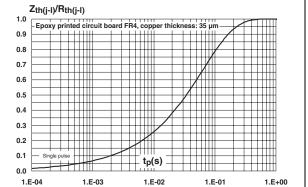


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration





Characteristics STPS2L60-Y

Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

I<sub>R</sub>(μA)

1.E+04

1.E+04

1.E+04

1.E+04

1.E+04

1.E+03

1.E+02

1.E+01

1.E+01

1.E+01

1.E+01

1.E+01

1.E+01

1.E+01

1.E+02

Figure 8. Junction capacitance versus reverse voltage applied (typical values)

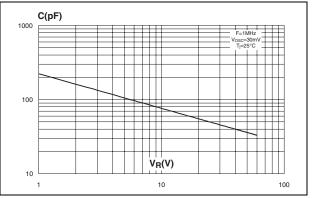


Figure 9. Forward voltage drop versus forward current (maximum values, low level)

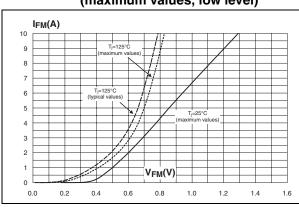
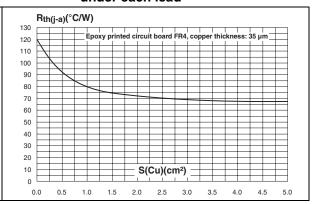


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead



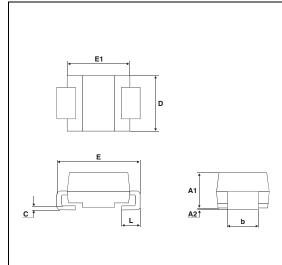
4/7 Doc ID 018927 Rev 1

# 2 Package information

- Epoxy meets UL94, V0
- Lead-free package

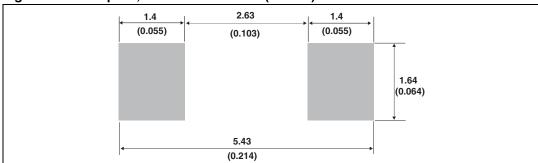
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: <a href="www.st.com">www.st.com</a>. ECOPACK® is an ST trademark.

Table 5. SMA dimensions



	Dimensions			
Ref.	Millimeters		Inc	hes
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.094
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
С	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
Е	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

Figure 11. Footprint, dimensions in mm (inches)



Ordering information STPS2L60-Y

# **3 Ordering information**

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS2L60AY	S26Y	SMA	0.068 g	5000	Tape and reel

# 4 Revision history

Table 7. Document revision history

Date	Revision	Changes
02-Nov-2011	1	Initial release.

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